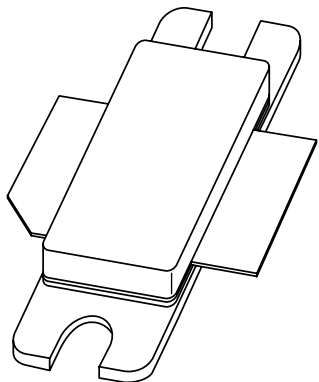


DATA SHEET



BLF2047 UHF power LDMOS transistor

Product specification
Supersedes data of 1999 Jul 01

1999 Dec 02

UHF power LDMOS transistor

BLF2047

FEATURES

- High power gain
- Easy power control
- Excellent ruggedness
- Source on underside eliminates DC isolators, reducing common mode inductance
- Designed for broadband operation (1.8 to 2.2 GHz).
- Internal input and output matching for high gain and efficiency

APPLICATIONS

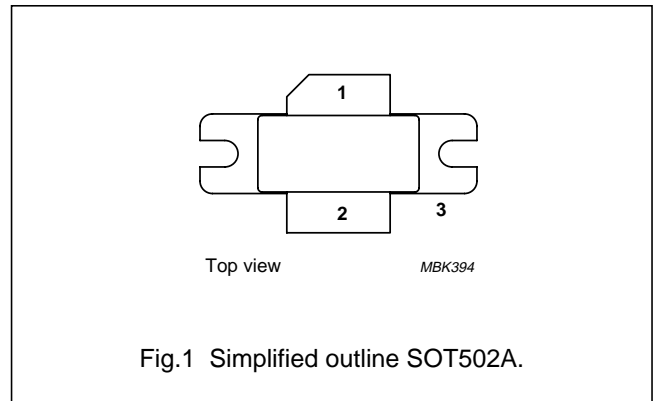
- Common source class-AB operation for PCN and PCS applications in the 1800 to 2200 MHz frequency range.

DESCRIPTION

Silicon N-channel enhancement mode lateral D-MOS transistor encapsulated in a 2-lead flange SOT502A package with a ceramic cap. The common source is connected to the mounting flange.

PINNING

| PIN | DESCRIPTION |
|-----|----------------------------|
| 1 | drain |
| 2 | gate |
| 3 | source connected to flange |



QUICK REFERENCE DATA

RF performance at $T_h = 25\text{ }^\circ\text{C}$ in a common source test circuit.

| MODE OF OPERATION | f (MHz) | V _{DS} (V) | P _L (W) | G _p (dB) | η_D (%) | d _{im} (dBc) |
|--------------------|--|---------------------|--------------------|---------------------|--------------|-----------------------|
| Two-tone, class-AB | f ₁ = 2200; f ₂ = 2200.1 | 26 | 65 (PEP) | >10 | >30 | ≤-25 |
| | | 28 | 65 (PEP) | typ. 12.6 | typ. 31 | typ. -29 |

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | MIN. | MAX. | UNIT |
|-----------|----------------------|------|------|------|
| V_{DS} | drain-source voltage | – | 65 | V |
| V_{GS} | gate-source voltage | – | ±15 | V |
| I_D | DC drain current | – | 9 | A |
| T_{stg} | storage temperature | –65 | +150 | °C |
| T_j | junction temperature | – | 200 | °C |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|--|--|-------|------|
| $R_{th\ j-h}$ | thermal resistance from junction to heatsink | $T_h = 25\text{ °C}$, $P_{tot} = 152\text{ W}$, note 1 | 1.15 | K/W |

Note

1. Determined under specified RF operating conditions, based on maximum peak junction temperature.

CHARACTERISTICS $T_j = 25\text{ °C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---------------|----------------------------------|--|------|------|------|------|
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $V_{GS} = 0$; $I_D = 1.4\text{ mA}$ | 65 | – | – | V |
| V_{GSth} | gate-source threshold voltage | $V_{DS} = 10\text{ V}$; $I_D = 140\text{ mA}$ | 1.5 | – | 3.5 | V |
| I_{DSS} | drain-source leakage current | $V_{GS} = 0$; $V_{DS} = 26\text{ V}$ | – | – | 10 | μA |
| I_{DSX} | on-state drain current | $V_{GS} = V_{GSth} + 9\text{ V}$; $V_{DS} = 10\text{ V}$ | 18 | – | – | A |
| I_{GSS} | gate leakage current | $V_{GS} = \pm 15\text{ V}$; $V_{DS} = 0$ | – | – | 250 | nA |
| g_{fs} | forward transconductance | $V_{DS} = 10\text{ V}$; $I_D = 5\text{ A}$ | – | 4 | – | S |
| R_{DSon} | drain-source on-state resistance | $V_{GS} = V_{GSth} + 9\text{ V}$; $I_D = 5\text{ A}$ | – | 0.17 | – | Ω |
| C_{rss} | feedback capacitance | $V_{GS} = 0$; $V_{DS} = 26\text{ V}$; $f = 1\text{ MHz}$ | – | 3.4 | – | pF |

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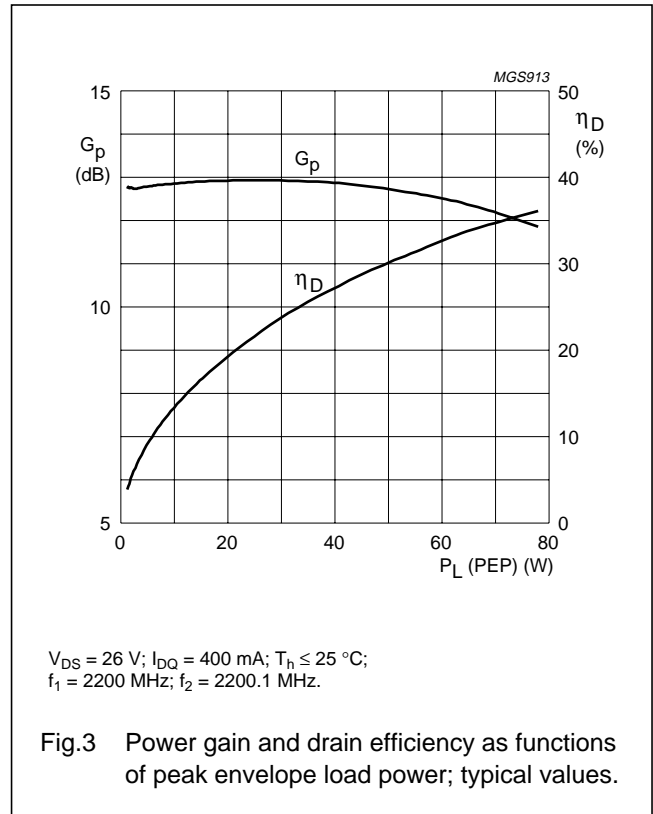
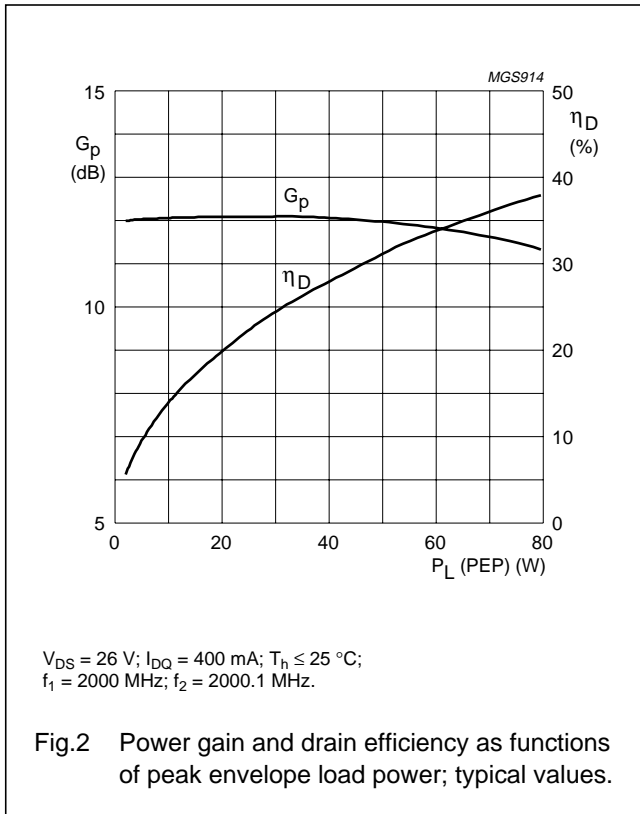
APPLICATION INFORMATION

RF performance in a common source class-AB circuit. $T_h = 25\text{ }^\circ\text{C}$; $R_{th\ j-h} = 1.15\text{ K/W}$; unless otherwise specified.

| MODE OF OPERATION | f (MHz) | V _{DS} (V) | I _{DQ} (mA) | P _L (W) | G _p (dB) | η _D (%) | d _{im} (dBc) |
|--------------------|--|---------------------|----------------------|--------------------|---------------------|--------------------|-----------------------|
| Two-tone, class-AB | f ₁ = 2200; f ₂ = 2200.1 | 26 | 400 | 65 (PEP) | >10 | >30 | ≤ -25 |
| | | 28 | 400 | 65 (PEP) | typ. 12.6 | typ. 31 | typ. -29 |

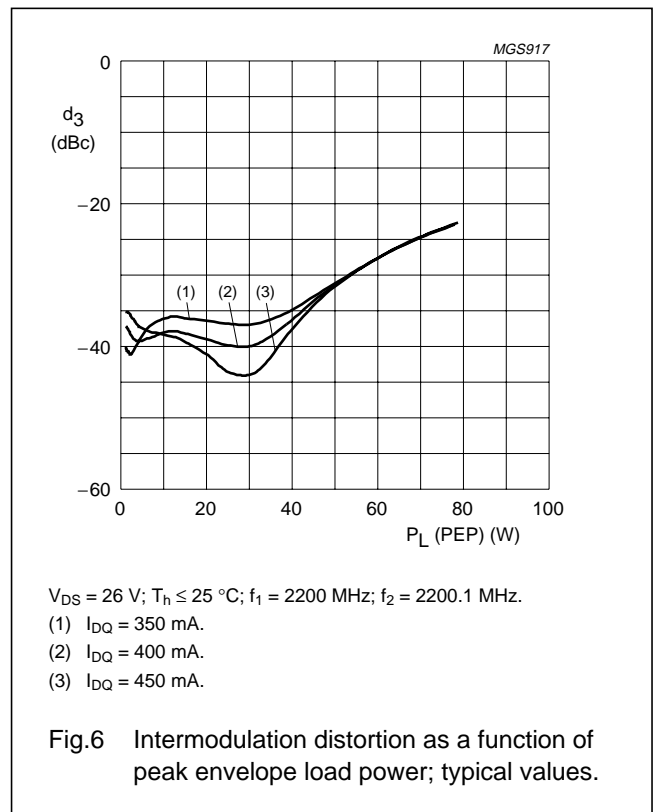
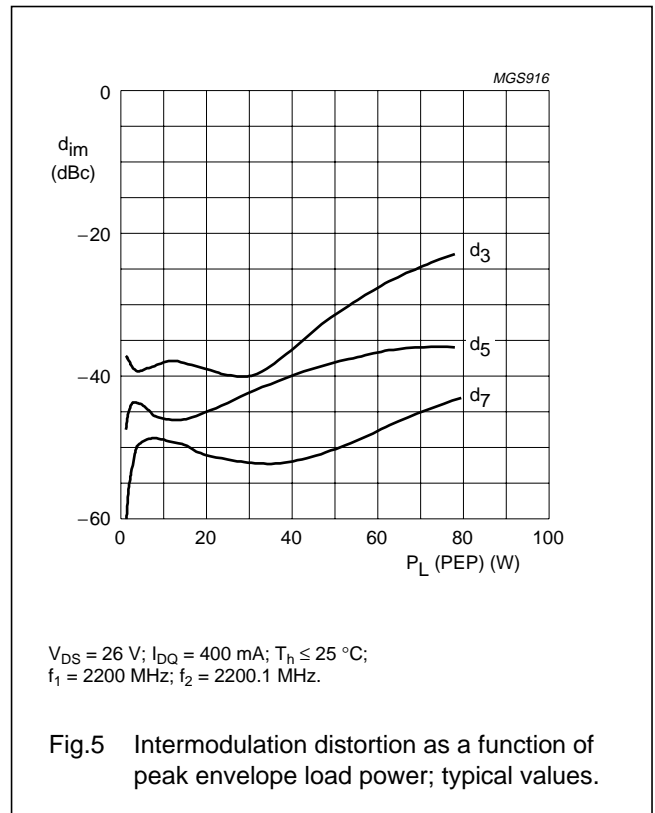
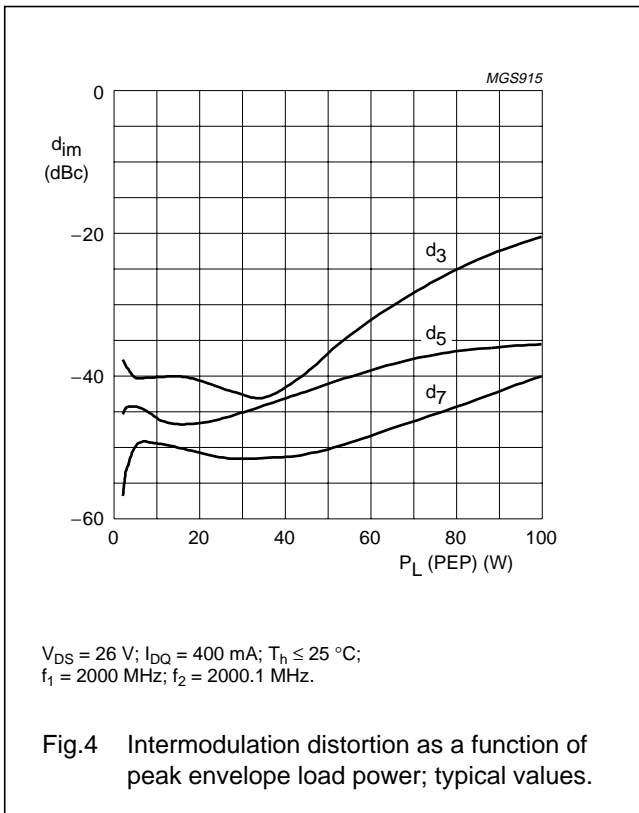
Ruggedness in class-AB operation

The BLF2047 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 26 V; I_{DQ} = 400 mA; P_L = 65 W (CW); f = 2200 MHz.



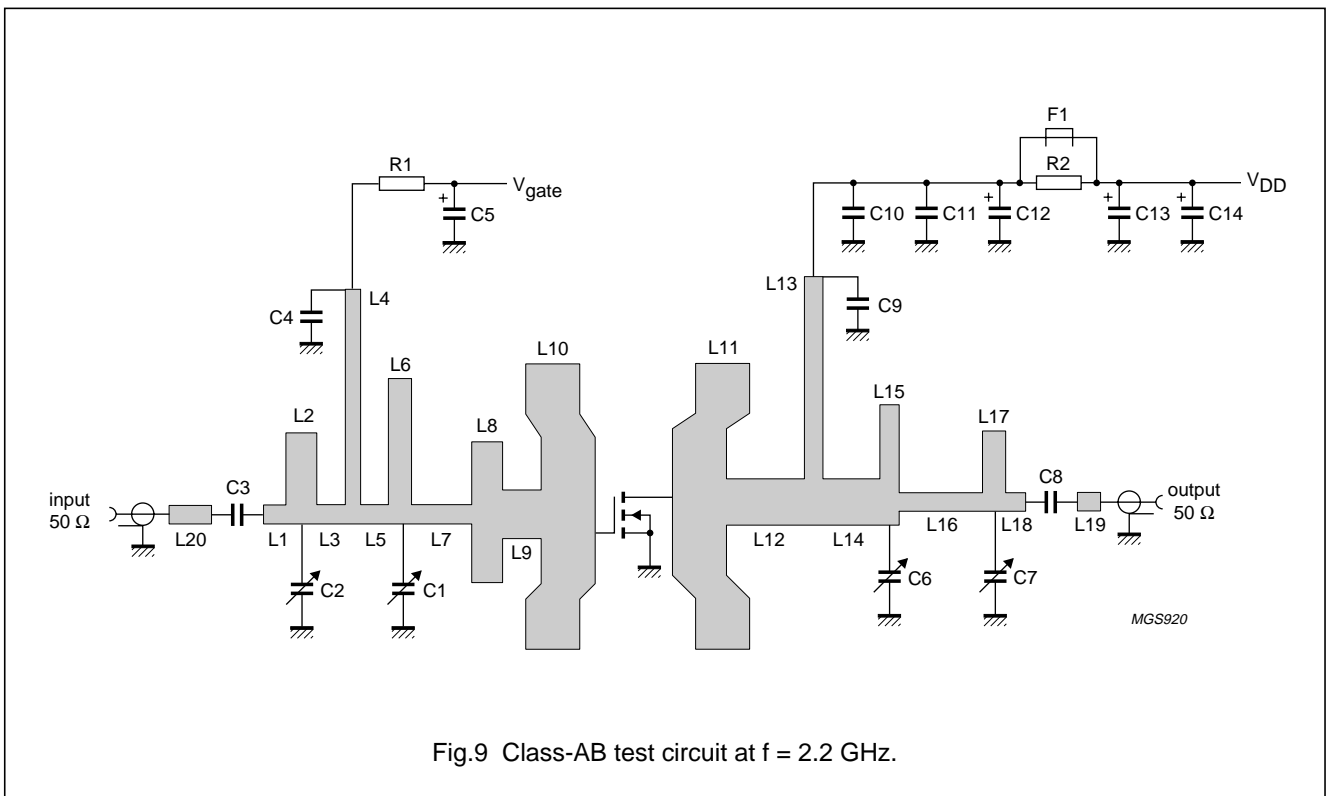
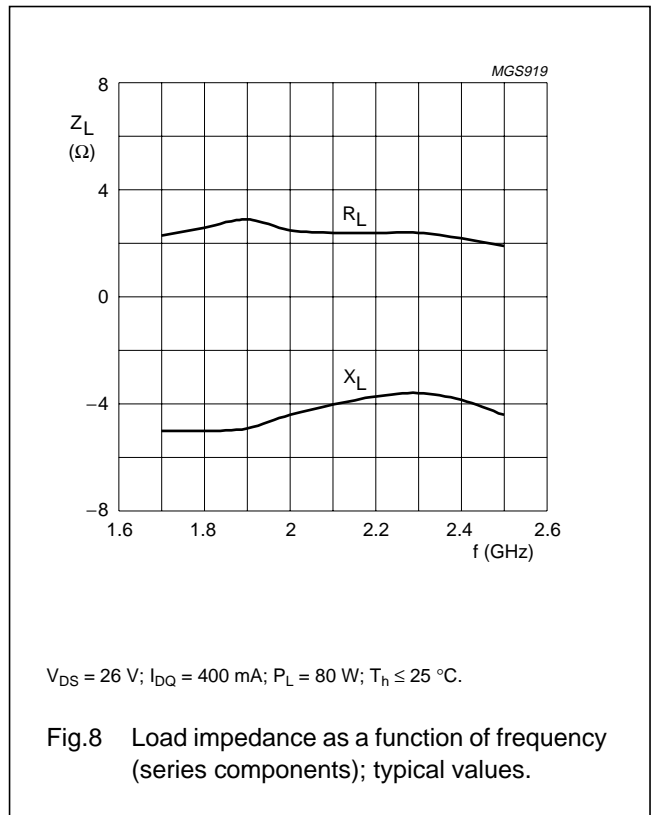
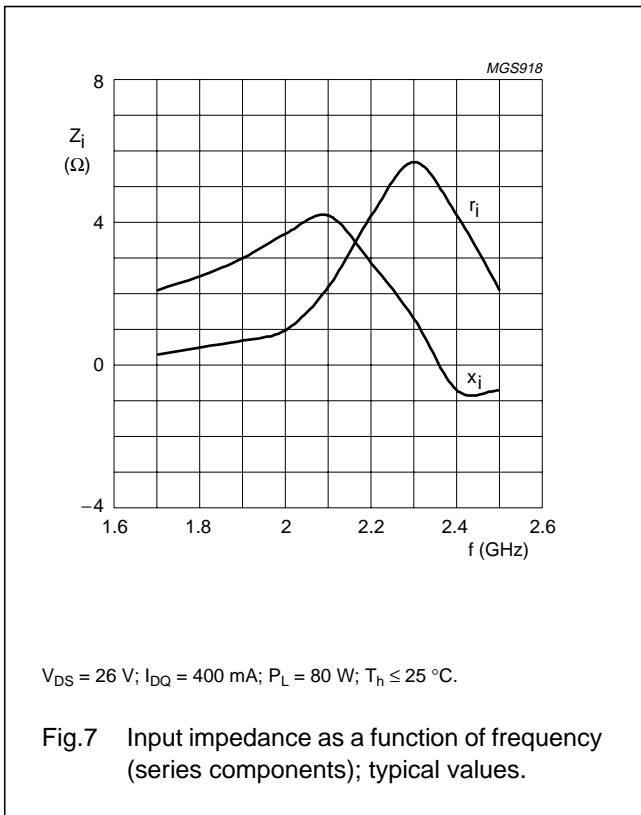
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List of components (See Figs 9 and 10)

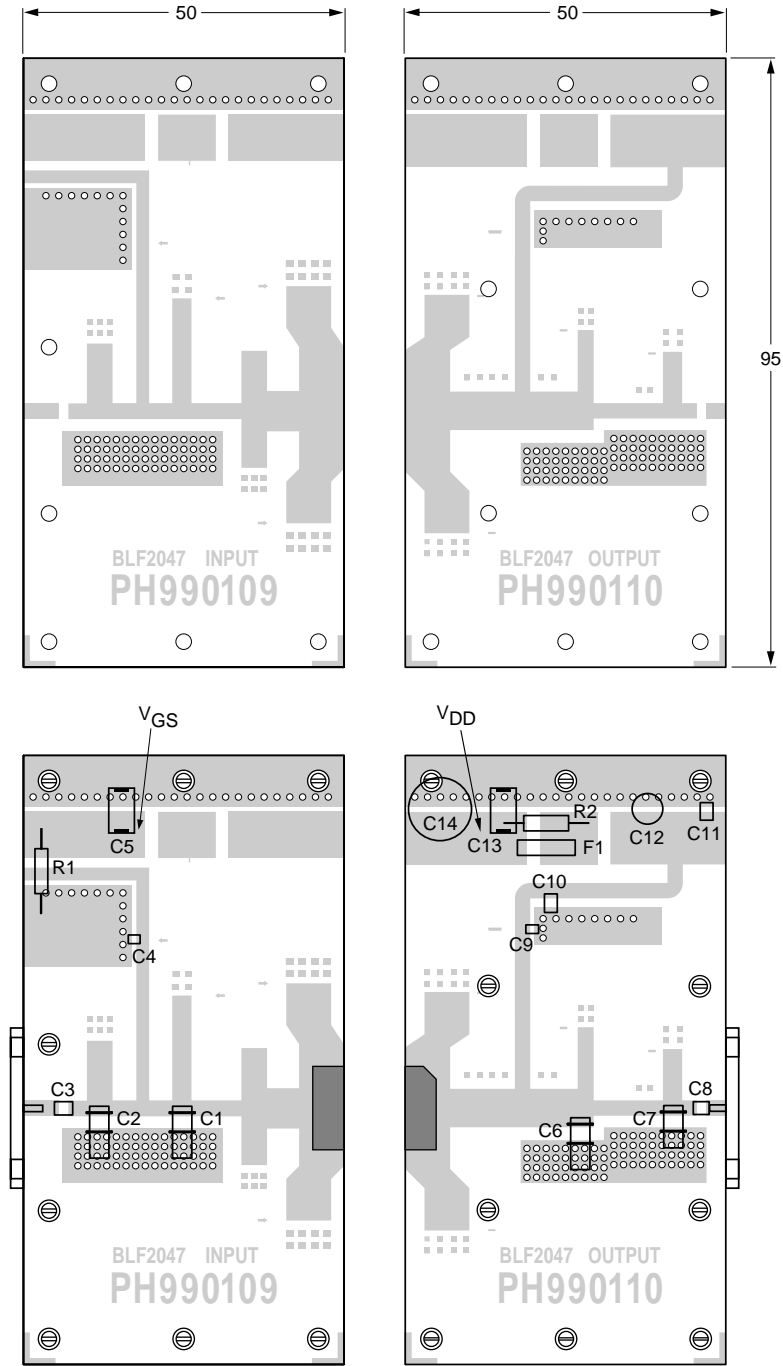
| COMPONENT | DESCRIPTION | VALUE | DIMENSIONS | CATALOGUE NO. |
|----------------|---|---------------------|----------------------|----------------|
| C1, C2, C6, C7 | Tekelec variable capacitor; type 37281 | 0.4 to 2.5 pF | | |
| C3, C8 | multilayer ceramic chip capacitor; note 1 | 12 pF | | |
| C4, C9 | multilayer ceramic chip capacitor; note 2 | 12 pF | | |
| C5, C12 | electrolytic capacitor | 10 μ F; 100 V | | 2222 037 59109 |
| C10 | multilayer ceramic chip capacitor; note 1 | 1 nF | | |
| C11 | multilayer ceramic chip capacitor | 100 nF | | 2222 581 16641 |
| C13 | tantal SMD capacitor | 4.5 μ F; 50 V | | |
| C14 | electrolytic capacitor | 100 μ F; 63 V | | 2222 037 58101 |
| F1 | Ferroxcube chip-bead 8DS3/3/8/9-4S2 | | | 4330 030 36301 |
| L1 | stripline; note 3 | 50 Ω | 2.9 \times 2.4 mm | |
| L2 | stripline; note 3 | 14.5 Ω | 4 \times 11.7 mm | |
| L3 | stripline; note 3 | 50 Ω | 3.7 \times 2.4 mm | |
| L4 | stripline; note 3 | 6 Ω | 2 \times 30.8 mm | |
| L5 | stripline; note 3 | 50 Ω | 3.6 \times 2.4 mm | |
| L6 | stripline; note 3 | 9.5 Ω | 3 \times 18.8 mm | |
| L7 | stripline; note 3 | 50 Ω | 7.8 \times 2.4 mm | |
| L8 | stripline; note 3 | 9.8 Ω | 4 \times 18.3 mm | |
| L9 | stripline; note 3 | 24.4 Ω | 5 \times 6.3 mm | |
| L10, L11 | stripline; note 3 | 5.1 Ω | 7 \times 37 mm | |
| L12 | stripline; note 3 | 25.4 Ω | 10.1 \times 6 mm | |
| L13 | stripline; note 3 | 5.7 Ω | 2.4 \times 32.8 mm | |
| L14 | stripline; note 3 | 25.4 Ω | 7.4 \times 6 mm | |
| L15 | stripline; note 3 | 11.3 Ω | 2.5 \times 15.6 mm | |
| L16 | stripline; note 3 | 50 Ω | 10.8 \times 2.4 mm | |
| L17 | stripline; note 3 | 16.1 Ω | 3 \times 10.4 mm | |
| L18 | stripline; note 3 | 50 Ω | 2.3 \times 2.4 mm | |
| L19 | stripline; note 3 | 50 Ω | 3 \times 2.4 mm | |
| L20 | stripline; note 3 | 50 Ω | 5.5 \times 2.4 mm | |
| R1, R2 | metal film resistor | 10 Ω , 0.6 W | | 2322 156 11009 |

Notes

1. American Technical Ceramics type 100B or capacitor of same quality.
2. American Technical Ceramics type 100A or capacitor of same quality.
3. The striplines are on a double copper-clad printed-circuit board with Teflon dielectric ($\epsilon_r = 2.2$); thickness 0.79 mm.

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Dimensions in mm.

The components are situated on one side of the copper-clad printed-circuit board with Teflon dielectric ($\epsilon_r = 2.2$), thickness 0.79 mm. The other side is unetched and serves as a ground plane.

Fig.10 Component layout for 2.2 GHz class-AB test circuit.

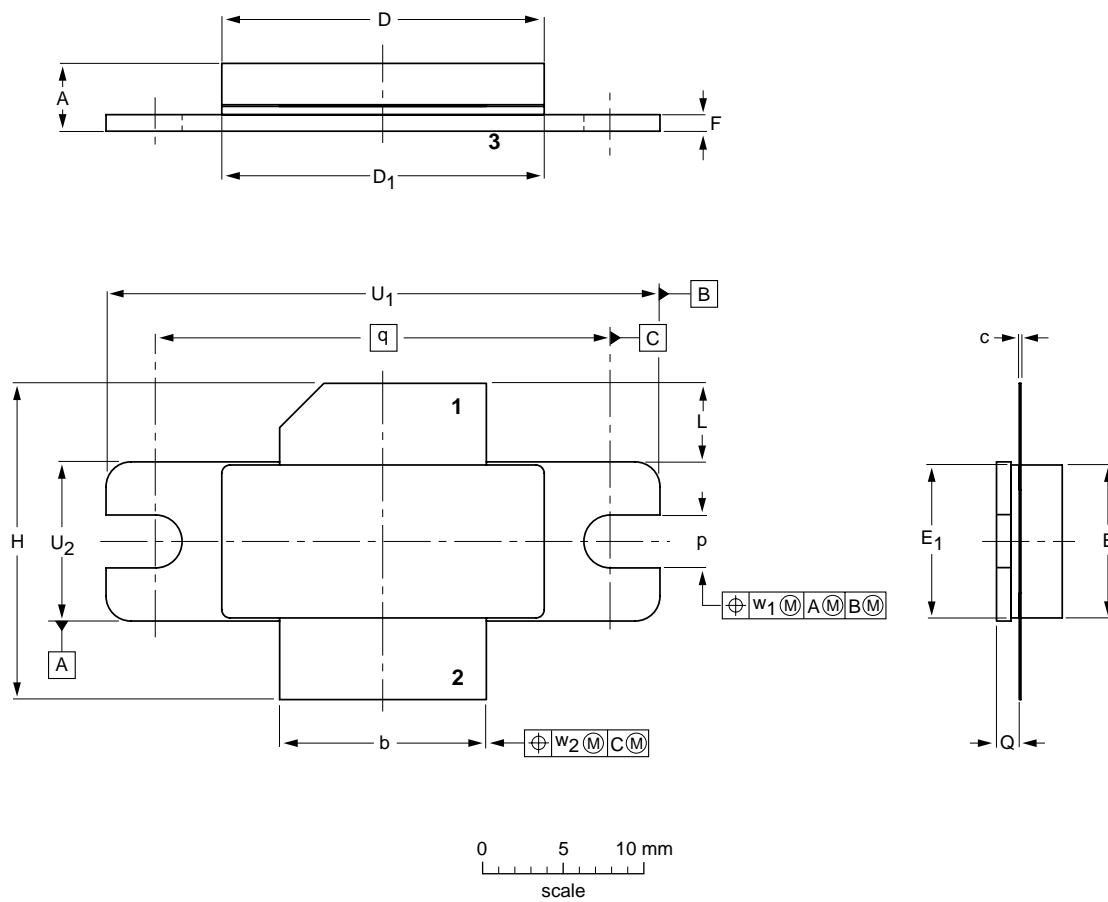
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PACKAGE OUTLINE

Flanged LDMOST package; 2 mounting holes; 2 leads

SOT502A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

| UNIT | A | b | c | D | D ₁ | E | E ₁ | F | H | L | p | Q | q | U ₁ | U ₂ | w ₁ | w ₂ |
|--------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|----------------|-------|----------------|----------------|----------------|----------------|
| mm | 4.72 3.99 | 12.83 12.57 | 0.15 0.08 | 20.02 19.61 | 19.96 19.66 | 9.50 9.30 | 9.53 9.25 | 1.14 0.89 | 19.94 18.92 | 5.33 4.32 | 3.38 3.12 | 1.70 1.45 | 27.94 | 34.16 33.91 | 9.91 9.65 | 0.25 | 0.51 |
| inches | 0.186 0.157 | 0.505 0.495 | 0.006 0.003 | 0.788 0.772 | 0.786 0.774 | 0.374 0.366 | 0.375 0.364 | 0.045 0.035 | 0.785 0.745 | 0.210 0.170 | 0.133 0.123 | 0.067 0.057 | 1.100 | 1.345 1.335 | 0.390 0.380 | 0.01 | 0.02 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|-----------------|------------|-------|------|--|---------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT502A | | | | | | 99-06-07 99-10-13 |

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DEFINITIONS

| | |
|---|---|
| Data Sheet Status | |
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |

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